

MITSUBISHI HVIGBT MODULES
CM1200DC-34N

4th-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE
 INSULATED TYPE

CM1200DC-34N



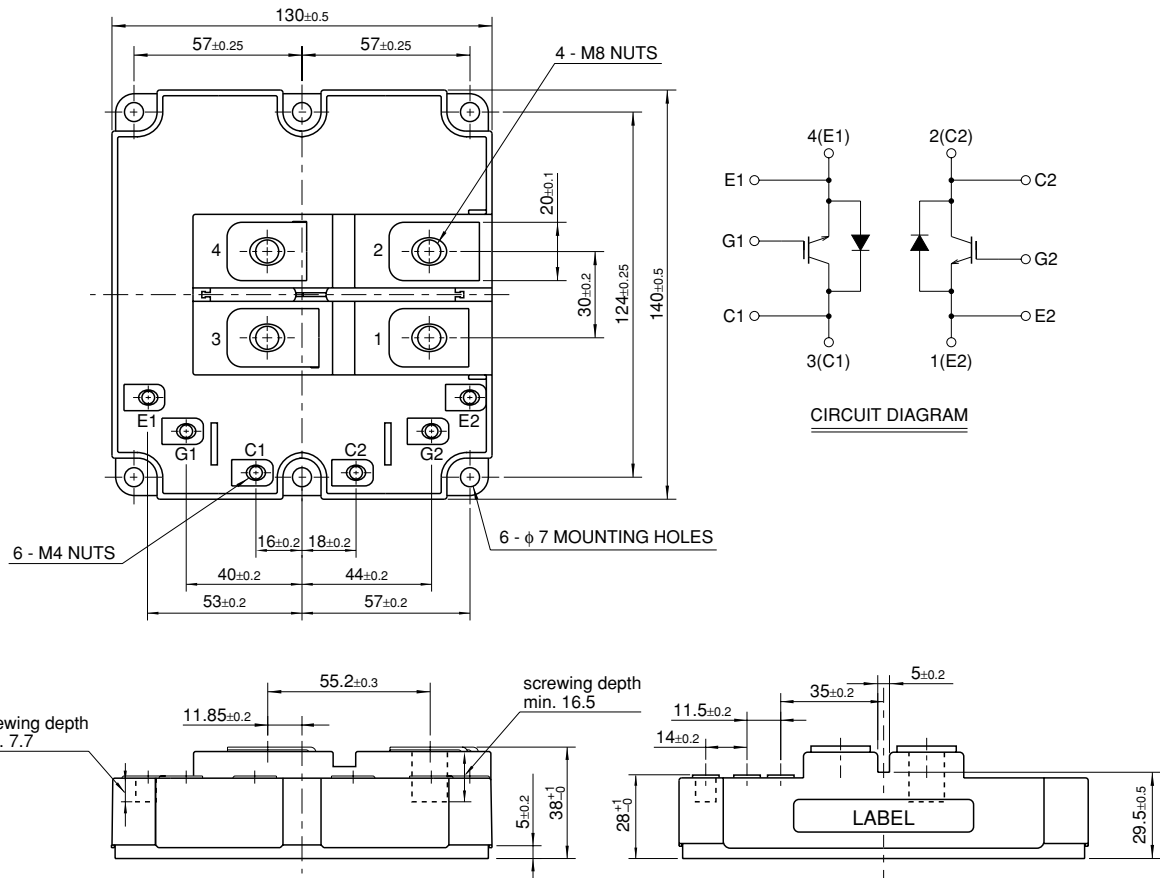
- Ic 1200A
- VCES 1700V
- Insulated Type
- 2-element in a Pack
- AISiC Baseplate
- Trench Gate IGBT : CSTBT™
- Soft Reverse Recovery Diode

APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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Jul. 2005

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MAXIMUM RATINGS

Symbol	Item	Conditions	Ratings	Unit
V _{CE} S	Collector-emitter voltage	V _{GE} = 0V, T _j = 25°C	1700	V
V _{GE} S	Gate-emitter voltage	V _{CE} = 0V, T _j = 25°C	±20	V
I _C	Collector current	T _C = 75°C	1200	A
I _{CM}		Pulse (Note 1)	2400	A
I _E (Note 2)	Emitter current		1200	A
I _{EM} (Note 2)		Pulse (Note 1)	2400	A
P _C (Note 3)	Maximum power dissipation	T _C = 25°C, IGBT part	6500	W
T _j	Junction temperature		-40 ~ +150	°C
T _{op}	Operating temperature		-40 ~ +125	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	RMS, sinusoidal, f = 60Hz, t = 1min.	4000	V
t _p sc	Maximum short circuit pulse width	V _{CC} = 1200V, V _{CE} ≤ 1700V, V _{GE} = 15V T _j = 125°C	10	μs

ELECTRICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
I _{CE} S	Collector cut-off current	V _{CE} = V _{CE} S, V _{GE} = 0V, T _j = 25°C	—	—	4	mA
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 120mA, V _{CE} = 10V, T _j = 25°C	6.0	7.0	8.0	V
I _{GE} S	Gate leakage current	V _{GE} = V _{GE} S, V _{CE} = 0V, T _j = 25°C	—	—	0.5	μA
V _{CE(sat)}	Collector-emitter saturation voltage	I _C = 1200A, V _{GE} = 15V, T _j = 25°C (Note 4)	—	2.15	2.80	V
		I _C = 1200A, V _{GE} = 15V, T _j = 125°C (Note 4)	—	2.40	—	
C _{ies}	Input capacitance	V _{CE} = 10V, f = 100kHz V _{GE} = 0V, T _j = 25°C	—	176	—	nF
C _{oes}	Output capacitance		—	9.6	—	nF
C _{res}	Reverse transfer capacitance		—	2.8	—	nF
Q _g	Total gate charge	V _{CC} = 850V, I _C = 1200A, V _{GE} = 15V, T _j = 25°C	—	6.8	—	μC
V _{EC} (Note 2)	Emitter-collector voltage	I _E = 1200A, V _{GE} = 0V, T _j = 25°C (Note 4)	—	2.60	3.30	V
		I _E = 1200A, V _{GE} = 0V, T _j = 125°C (Note 4)	—	2.30	—	
t _{d(on)}	Turn-on delay time	V _{CC} = 850V, I _C = 1200A, V _{GE} = ±15V R _{G(on)} = 1.3Ω, T _j = 125°C, L _s = 150nH Inductive load	—	1.00	—	μs
t _r	Turn-on rise time		—	0.40	—	μs
E _{on}	Turn-on switching energy	V _{CC} = 850V, I _C = 1200A, V _{GE} = ±15V R _{G(off)} = 3.3Ω, T _j = 125°C, L _s = 150nH Inductive load	—	380	—	mJ/pulse
t _{d(off)}	Turn-off delay time		—	1.20	—	μs
t _f	Turn-off fall time	V _{CC} = 850V, I _C = 1200A, V _{GE} = ±15V R _{G(off)} = 3.3Ω, T _j = 125°C, L _s = 150nH Inductive load	—	0.30	—	μs
E _{off}	Turn-off switching energy		—	360	—	mJ/pulse
t _{rr} (Note 2)	Reverse recovery time	V _{CC} = 850V, I _C = 1200A, V _{GE} = ±15V	—	1.00	—	μs
I _{rr} (Note 2)	Reverse recovery current	R _{G(on)} = 1.3Ω, T _j = 125°C, L _s = 150nH	—	560	—	A
Q _{rr} (Note 2)	Reverse recovery charge	Inductive load	—	300	—	μC
E _{rec} (Note 2)	Reverse recovery energy		—	220	—	mJ/pulse

- Note 1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{opmax} rating (125°C).
 Note 2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWDi).
 Note 3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).
 Note 4. Pulse width and repetition rate should be such as to cause negligible temperature rise.



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THERMAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
R _{th(j-c)Q}	Thermal resistance	Junction to Case, IGBT part, 1/2 module	—	—	19.0	K/kW
R _{th(j-c)R}		Junction to Case, FWDi part, 1/2 module	—	—	42.0	K/kW
R _{th(c-f)}	Contact thermal resistance	Case to Fin, $\lambda_{grease} = 1W/m \cdot K$, 1/2 module	—	16.0	—	K/kW

MECHANICAL CHARACTERISTICS

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
M	Mounting torque	M8 : Main terminals screw	7.0	—	20.0	N·m
		M6 : Mounting screw	3.0	—	6.0	
		M4 : Auxiliary terminals screw	1.0	—	3.0	
—	Mass		—	0.8	—	kg
CTI	Comparative tracking index		600	—	—	—
d _a	Clearance distance in air		9.5	—	—	mm
d _s	Creepage distance along surface		15.0	—	—	mm
LC-E(int)	Internal inductance	IGBT part	—	30	—	nH
RC-E(int)	Internal lead resistance	T _C = 25°C	—	0.28	—	mΩ

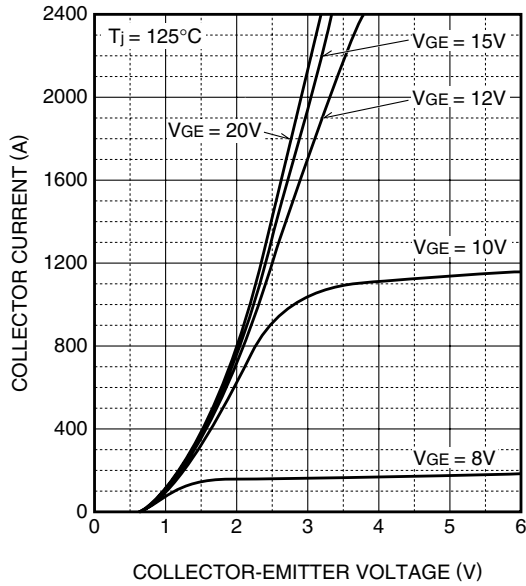
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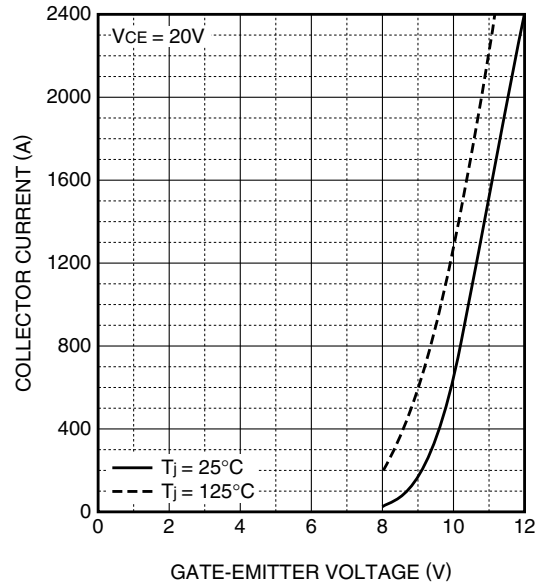
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PERFORMANCE CURVES

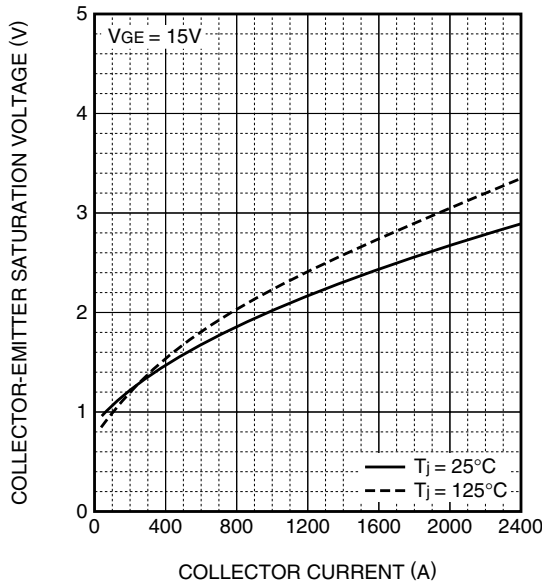
OUTPUT CHARACTERISTICS (TYPICAL)



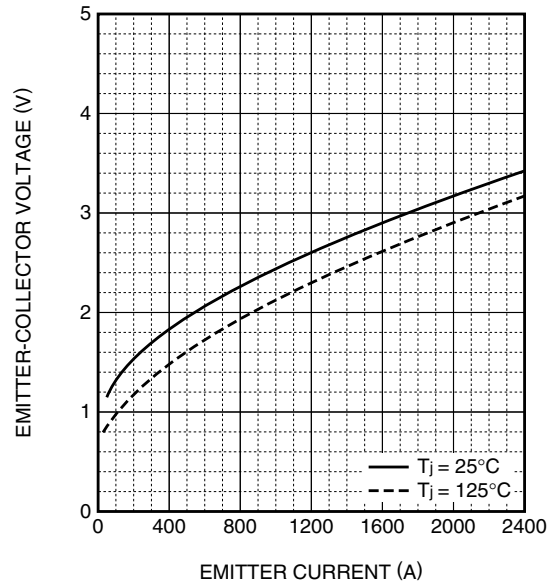
TRANSFER CHARACTERISTICS (TYPICAL)



COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



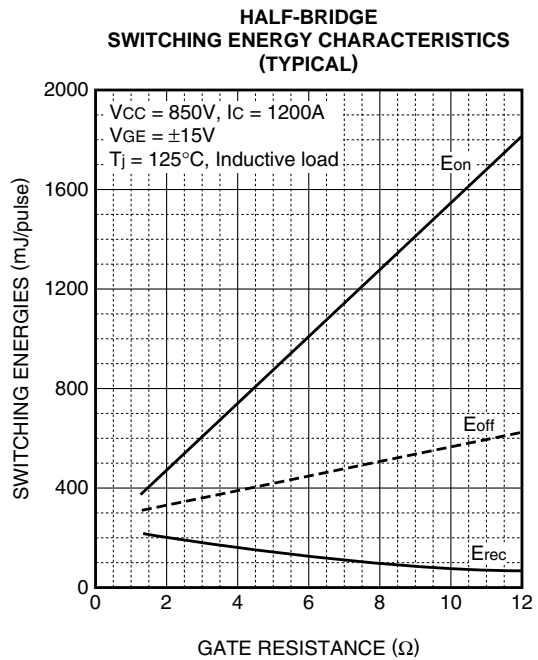
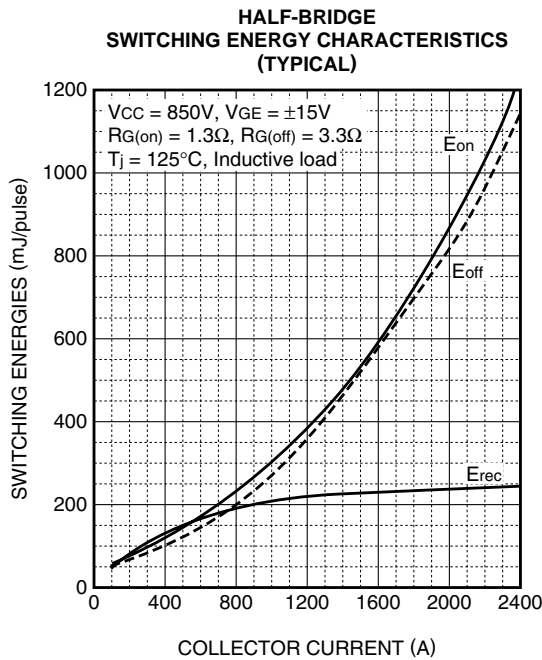
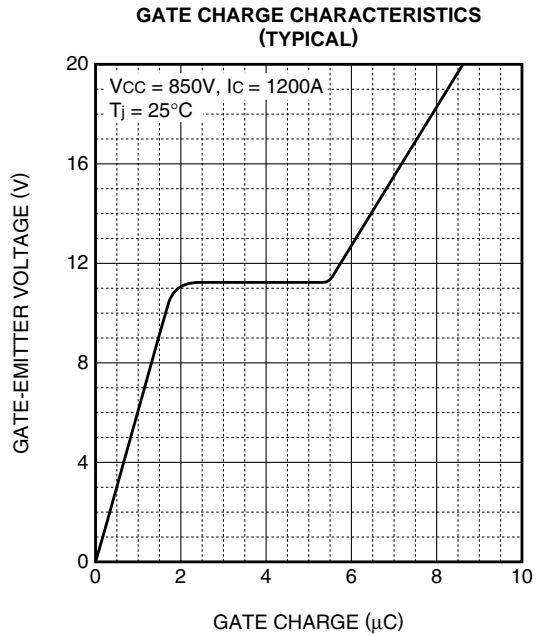
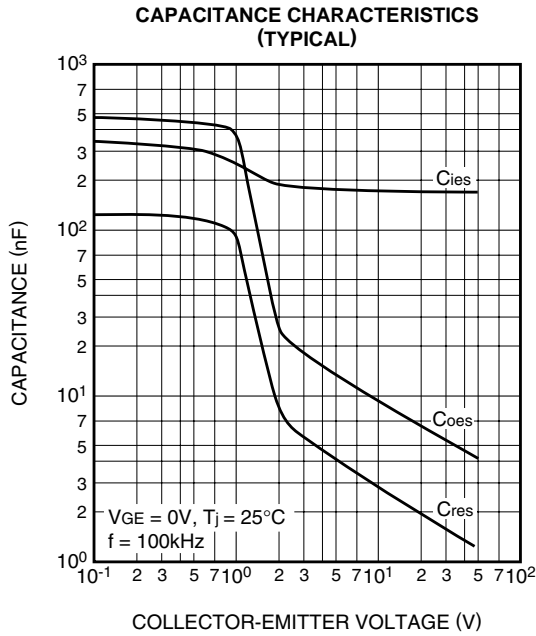
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



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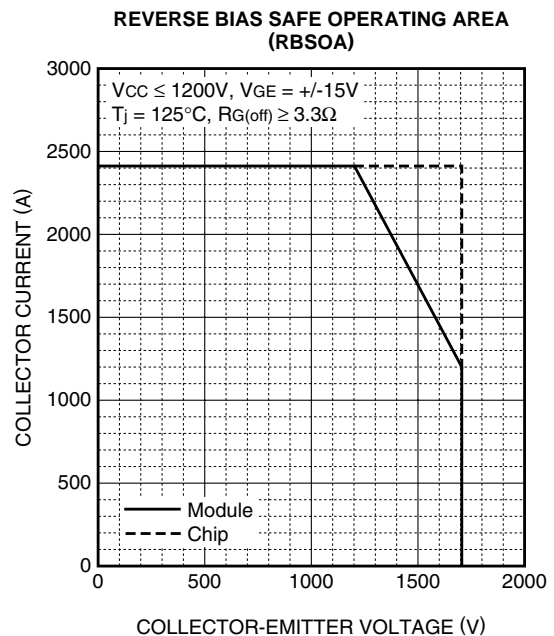
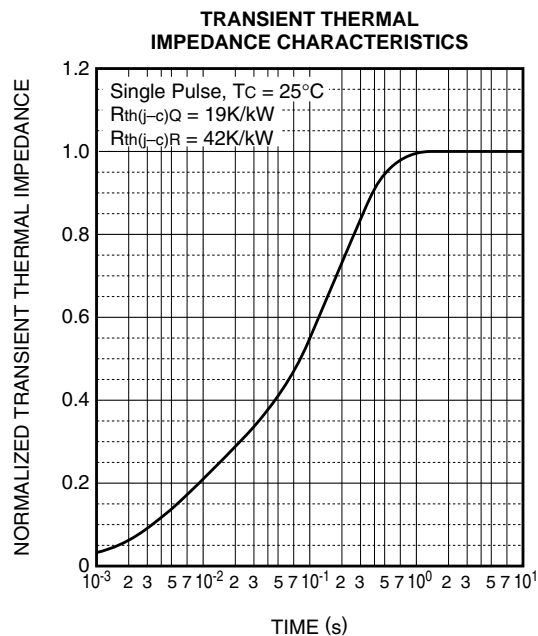
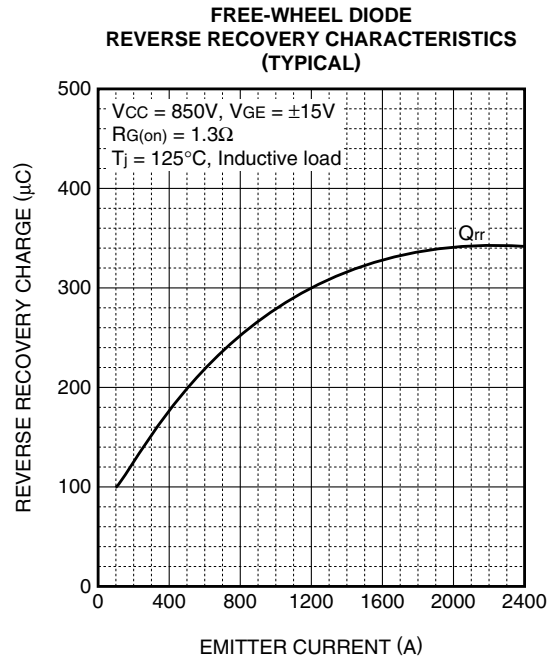
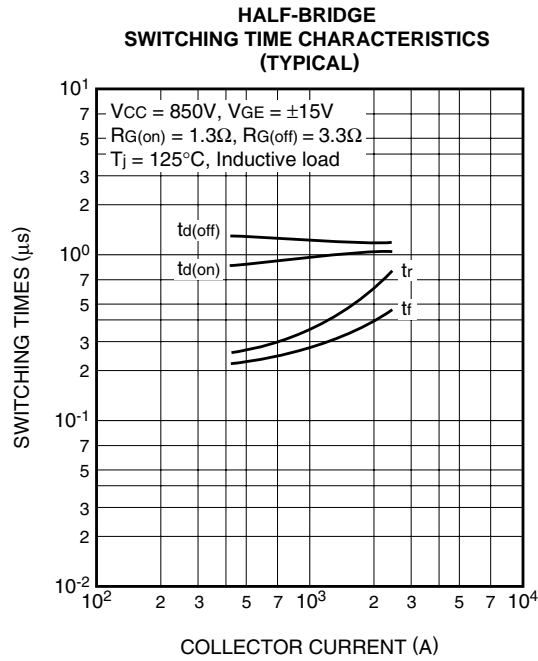
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